

10567318

PATENT

Amendments to the Specification

At the top of the first page, just under the title, insert:

Cross Reference to Related Applications

- - This application is the National Phase of International Application PCT/EP2004/051709 filed August 4, 2004 which designated the U.S. and which claims priority to Swiss (CH) Pat. App. No. 01363/03 filed August 7, 2003. The noted applications are incorporated herein by reference. - -

insert this *line 26,*
Please replace the last paragraph on the bottom of page 2 with the following amended paragraph:

The invention firstly relates to a process for the production of solder masks on a printed circuit [[as described in claim 1]] in accordance with the present invention.